



Specification of Automotive MLCC

• Supplier : Samsung electro-mechanics • Samsung P/N : CL10B102KB85PNC

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 1nF, 50V, ±10%, X7R, 0603

• AEC-Q 200 Specified

A. Samsung Part Number

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1	Series	Samsung Multi-layer Ceramic Capacitor					
2	Size	0603 (inch code)	L: 1.6	6 ± 0.1 mm	W:	0.8 ± 0.1 mm	
3	Dielectric	X7R	8	Inner electrode		Ni , Open mode	
4	Capacitance	1 nF		Termination		Cu , Ag-epoxy	
(5)	Capacitance	±10 %		Plating		Sn 100% (Pb Free)	
	tolerance		9	Product		Automotive	
6	Rated Voltage	50 V	10	Grade code		Standard	
7	Thickness	0.8 ± 0.1 mm	11	Packaging		Cardboard Type, 7" reel	

B. Reliablility Test and Judgement condition

	Performance	Test condition			
High Temperature	Appearance : No abnormal exterior appearance	Unpowered, 1000hrs@T=150℃			
Exposure	Capacitance Change : Within ±10%	Measurement at 24±2hrs after test conclusion			
	Tan δ : 0.03 max				
	IR : More than 10,000⋒Ω or 500⋒Ω×μF				
	Whichever is Smaller				
Temperature Cycling	Appearance : No abnormal exterior appearance	1000Cycles			
	Capacitance Change : Within ±10%	Measurement at 24±2hrs after test conclusion			
	Tan δ : 0.03 max	1 cycle condition :			
	IR : More than 10,000⋒Ω or 500⋒Ω×μF	-55+0/-3°C(15±3min) -> Room Temp(1min.)			
	Whichever is Smaller	-> 125+3/-0°C(15±3min) -> Room Temp(1min.)			
Destructive Physical	No Defects or abnormalities	Per EIA 469			
Analysis					
Moisture Resistance	Appearance : No abnormal exterior appearance	10Cycles, t=24hrs/cycle			
	Capacitance Change : Within ±12.5%	Heat (25~65℃) and humidity (80~98%), Unpowered			
	Tan δ : 0.03 max	measurement at 24±2hrs after test conclusion			
	IR : More than 10,000⋒Ω or 500⋒Ω×μF				
	Whichever is Smaller				
Humidity Bias	Appearance : No abnormal exterior appearance	1000hrs 85℃/85%RH, Rated Voltate and 1.3~1.5V,			
	Capacitance Change : Within ±12.5%	Add 100kohm resistor			
	Tan δ : 0.035 max	Measurement at 24±2hrs after test conclusion			
	IR : More than 500MΩ or 25MΩ×μF	The charge/discharge current is less than 50mA.			
	Whichever is Smaller				
High Temperature	Appearance : No abnormal exterior appearance	1000hrs @ TA=125℃, 200% Rated Voltage,			
Operating Life	Capacitance Change : Within ±12.5%	Measurement at 24±2hrs after test conclusion			
	Tan δ : 0.035 max	The charge/discharge current is less than 50mA.			
	IR : More than 1000MΩ or 50MΩ×μF				
	Whichever is Smaller				

	Performance	Test condition			
External Visual	No abnormal exterior appearance	Microscope ('10)			
Physical Dimensions	Within the specified dimensions	Using The calipers			
Mechanical Shock	Appearance : No abnormal exterior appearance	Three shocks in each direction should be applied along			
	Capacitance Change : Within ±10%	3 mutually perpendicular axes of the test specimen (18 shocks)			
	Tan δ, IR : initial spec.	Peakvalue Duration Wave Velocity			
		1,500G 0.5ms Half sine 4.7m/sec.			
Vibration	Appearance : No abnormal exterior appearance	5g's for 20min., 12cycles each of 3 orientations,			
	Capacitance Change : Within ±10%	Use 8"×5" PCB 0.031" Thick 7 secure points on one long side			
	Tan δ, IR : initial spec.	and 2 secure points at corners of opposite sides. Parts mounted			
	·	within 2" from any secure point. Test from 10~2000Hz.			
Resistance to	Appearance : No abnormal exterior appearance	Solder pot : 260±5℃, 10±1sec.			
Solder Heat	Capacitance Change : Within ±10%				
	Tan δ, IR : initial spec.				
Thermal Shock	Appearance : No abnormal exterior appearance	-55℃/+125℃.			
	Capacitance Change : Within ±10%	Note: Number of cycles required-300,			
	Tan δ, IR : initial spec.	Maximum transfer time-20 sec, Dwell time-15min. Air-Air			
ESD	Appearance : No abnormal exterior appearance	AEC-Q200-002			
	Capacitance Change : Within ±10%				
	Tan δ, IR : initial spec.				
Solderability	95% of the terminations is to be soldered	a) Drahaat at 155% for 4 hours. Immerse in colder for 50 at 245 15%			
Solderability		a) Preheat at 155°C for 4 hours, Immerse in solder for 5s at 245±5°C			
	evenly and continuously	b) Steam aging for 8 hours, Immerse in solder for 5s at 245±5°C			
		c) Steam aging for 8 hours, Immerse in solder for 120s at 260±5°C			
Electrical	Capacitance : Within specified tolerance	solder : a solution ethanol and rosin The Capacitance /D.F. should be measured at 25°C,			
Characterization	Tan δ (DF)0.025 max.	1 llt ±10%, 1.0±0.2 Vrms			
Ondraotorization	, ,	I.R. should be measured with a DC voltage not exceeding			
	IR(25 °C): More than 10,000 M Ω or 500 M Ω× μ F IR(125 °C): More than1,000 M Ω or 10 M Ω× μ F				
	Whichever is Smaller	Rated Voltage @25℃, @125℃ for 60~120 sec.			
	Dielectric Strength	Dielectric Strength: 250% of the rated voltage for 1~5 seconds			
Board Flex	Appearance : No abnormal exterior appearance	<u> </u>			
Dourd 1 lox	Capacitance Change: Within ±10%	bending to the limit (2 limit) for a seconds			
	Supusitation Sharige : Within 11070				
Terminal	Appearance : No abnormal exterior appearance	10N, for 60±1 sec.			
Strength(SMD) Capacitance Change: Within ±10%					
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Beam Load	Destruction value should not be exceed	Beam speed			
	Chip Length < 2.5mm	0.5±0.05mm/sec			
	a) Chip Thickness > 0.5mm : 20N				
	b) Chip Thickness ≤ 0.5mm : 8N				
Temperature X7R		•			
Characterisitcs	(From -55℃ to 125℃, Capacitance change sho	ud be within ±15%)			
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C. Recommended Soldering method:

 $[\]ensuremath{^{*}}$ For the more detail Specification, Please refer to the Samsung MLCC catalogue.